

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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CMKT2222A

SURFACE MOUNT DUAL NPN SMALL SIGNAL SILICON SWITCHING TRANSISTORS





www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMKT2222A consists of two individually isolated 2222A NPN silicon transistors, manufactured by the epitaxial planar process and epoxy molded in an SOT-363 surface mount package. This ULTRAmini™ device has been designed for small signal general purpose and switching applications.

MARKING CODE: K22

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MAXIMUM RATINGS: (T _A =25°C)		SYMBOL		UNITS
Collector-Base	Voltage	V _{CBO}	75	V
Collector-Emitter Voltage		V _{CEO}	40	V
Emitter-Base Voltage		V_{EBO}	6.0	V
Continuous Collector Current		IC	600	mA
Power Dissipation		P_{D}	350	mW
Operating and Storage Junction Temperature		T _J , T _{stg}	-65 to +150	°C
Thermal Resistance		$\Theta_{\sf JA}$	357	°C/W
	CHARACTERISTICS PER TRAI			
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I _{СВО}	V _{CB} =60V		10	nA
^I CBO	V _{CB} =60V, T _A =125°C		10	μΑ
ICEV	V_{CE} =60V, V_{EB} =3.0V		10	nA
I _{EBO}	V _{EB} =3.0V		10	nA
BV _{CBO}	I _C =10μA	75		V
BV _{CEO}	I _C =10mA	40		V
BV_{EBO}	I _E =10μA	6.0		V
V _{CE(SAT)}	I _C =150mA, I _B =15mA		0.3	V
V _{CE(SAT)}	I _C =500mA, I _B =50mA		1.0	V
V _{BE} (SAT)	I _C =150mA, I _B =15mA	0.6	1.2	V
V _{BE(SAT)}	I _C =500mA, I _B =50mA		2.0	V
h _{FE}	V_{CE} =10V, I_{C} =0.1mA	35		
hFE	V_{CE} =10V, I_{C} =1.0mA	50		
h _{FE}	V _{CE} =10V, I _C =10mA	75		
h _{FE}	V_{CE} =1.0V, I_{C} =150mA	50		
hFE	V _{CE} =10V, I _C =150mA	100	300	
h _{FE}	V _{CE} =10V, I _C =500mA	40		
f _T	V _{CE} =20V, I _C =20mA, f=100MHz	300		MHz
C _{ob}	V _{CB} =10V, I _E =0, f=1.0MHz		8.0	pF
C _{ib}	V_{EB} =0.5V, I_{C} =0, f=1.0MHz		25	pF

R4 (13-January 2010)

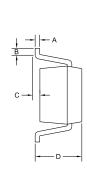
CMKT2222A

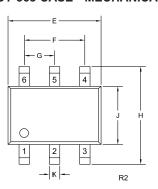




SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
h _{ie}	V_{CE} =10V, I_{C} =1.0mA, f=1.0kHz	2.0	8.0	kΩ
h _{ie}	V_{CE} =10V, I_{C} =10mA, f=1.0kHz	0.25	1.25	kΩ
h _{re}	V_{CE} =10V, I_{C} =1.0mA, f=1.0kHz		8.0	x10 ⁻⁴
h _{re}	V _{CE} =10V, I _C =10mA, f=1.0kHz		4.0	x10 ⁻⁴
h _{fe}	V_{CE} =10V, I_{C} =1.0mA, f=1.0kHz	50	300	
h _{fe}	V_{CE} =10V, I_{C} =10mA, f=1.0kHz	75	375	
h _{oe}	V_{CE} =10V, I_{C} =1.0mA, f=1.0kHz	5.0	35	μS
h _{oe}	V_{CE} =10V, I_{C} =10mA, f=1.0kHz	25	200	μS
rb'C _C	V_{CB} =10V, I_E =20mA, f=31.8MHz		150	ps
NF	V_{CE} =10V, I_{C} =100 μ A, R_{S} =1.0 $k\Omega$, f=1.0 kHz	4.0	dB	
^t d	V_{CC} =30V, V_{BE} =0.5V, I_{C} =150mA, I_{B1} =15mA		10	ns
t _r	V_{CC} =30V, V_{BE} =0.5V, I_{C} =150mA, I_{B1} =15mA		25	ns
t _s	V_{CC} =30V, I_{C} =150mA, I_{B1} = I_{B2} =15mA	225	ns	
t _f	V_{CC} =30V, I_{C} =150mA, I_{B1} = I_{B2} =15mA		60	ns

SOT-363 CASE - MECHANICAL OUTLINE





	SYMBOL	MIN	MAX	MIN	MAX		
	Α	0.004	0.010	0.10	0.25		
	В	0.005	-	0.12	-		
	С	0.000	0.004	0.00	0.10		
	D	0.031	0.043	0.80	1.10		
	Е	0.071	0.087	1.80	2.20		
	F	0.051		1.30			
	G	0.026		0.65			
	Н	0.075	0.091	1.90	2.30		
	J	0.043	0.055	1.10	1.40		
	K	0.006	0.012	0.15	0.30		
	SOT-363 (REV: R2)						

DIMENSIONS

INCHES MILLIMETERS

LEAD CODE: 1) Emitter Q1 2) Base Q1

- 3) Collector Q2
- 4) Emitter Q2
- 5) Base Q2
- 6) Collector Q1

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- · Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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